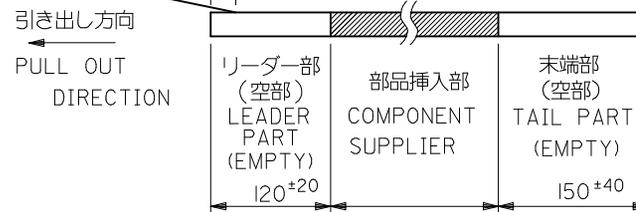


注記 NOTES

1. 製品番号 52746-***39 の梱包状態はアクチュエータがロックした状態とする。
 詳細寸法については図面 SD-52746-025 を参照下さい。
 IN THE PACKAGE,ACTUATOR OF PART NO.52746-***39 SHOULD BE LOCKED
 RE DETAILED DIMENSIONS,SEE SD-52746-025

2. 梱包数量：1000個/リール
 NUMBER OF CONNECTORS:1000PCS/REEL

3. リードテープ長さ LEAD TAPE LENGTH

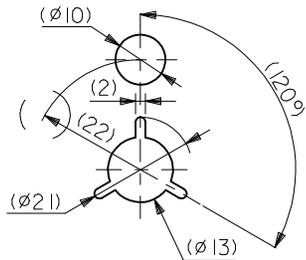
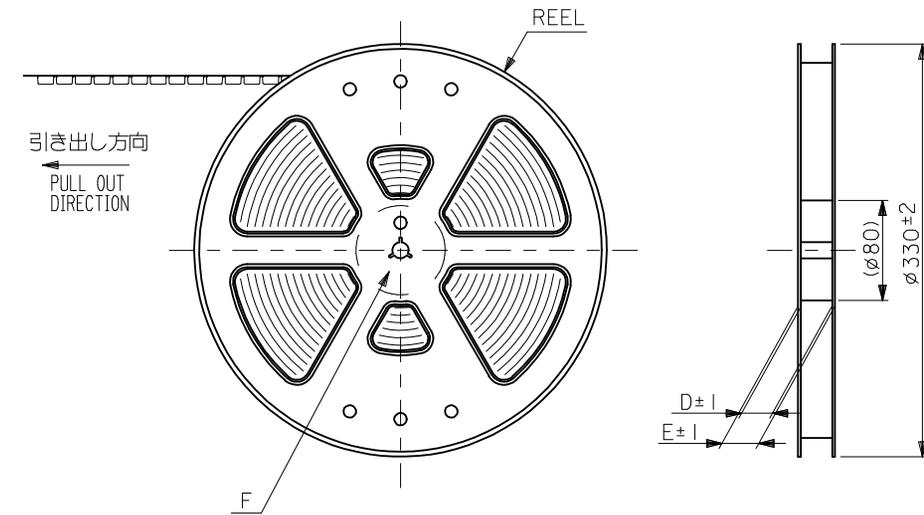
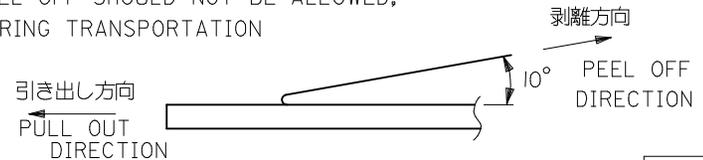


4. トップテープの剥離強度：(剥離方向は下図参照)

0. 1N~1.3N{10gf~130gf} 尚、本規格値は、出荷時に適用。
 (但し、輸送時に剥離が発生しない事。)

PEELING OFF FORCE OF TOP TAPE

0. 1N~1.3N{10gf~130gf}(PEELING DIRECTION AS SHOWN IN FOLLOWING FIG.)
 THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT
 PEEL OFF SHOULD NOT BE ALLOWED,
 DURING TRANSPORTATION



DETAIL F

5. 材料 キャリアテープ:ポリプロピレン (PP)
 トップテープ:PET, PE, PEF
 リール:ポリスチレン (PS) <リサイクル材を含む>

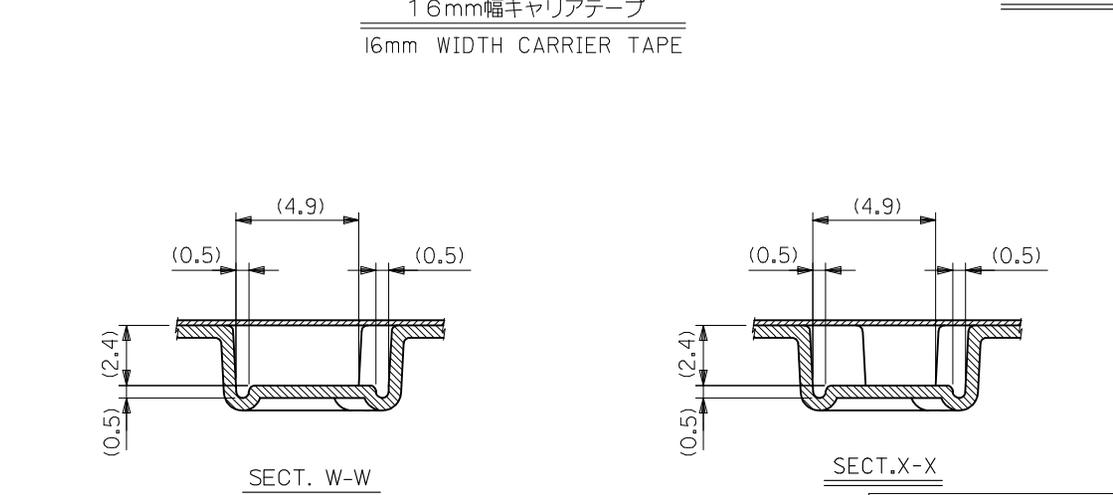
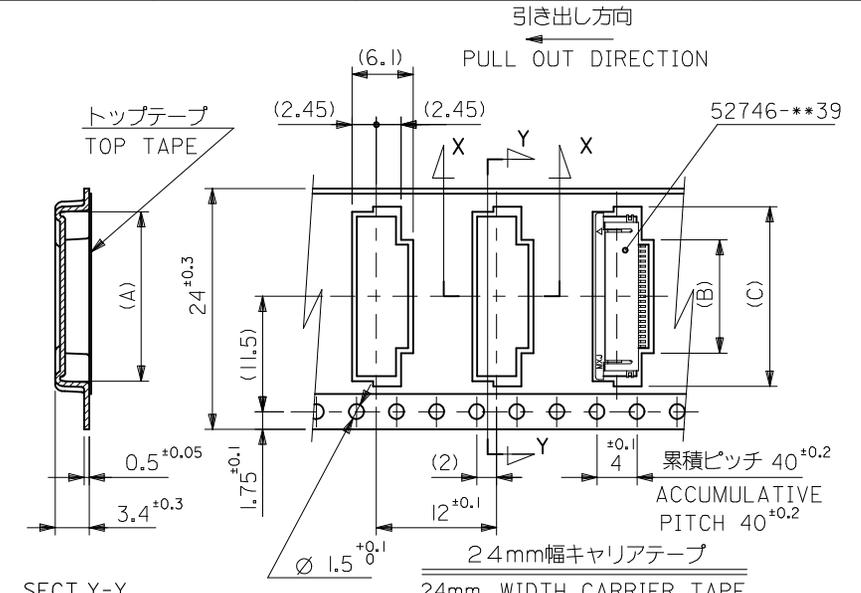
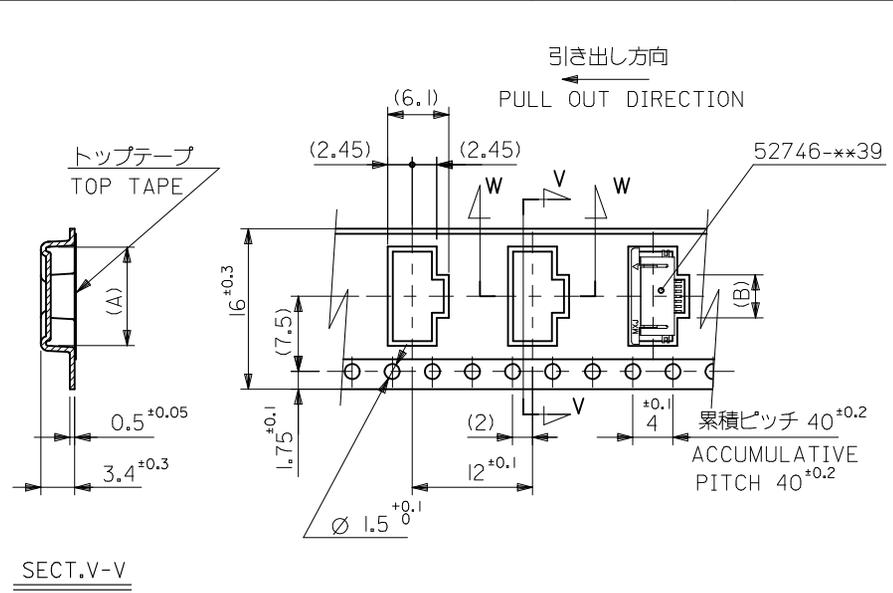
MATERIAL CARRIER TAPE:POLYPROPYLENE
 TOP TAPE:PET,PE,PEF
 REEL:POLYSTYRENE(PS)
 <RECYCLE MATERIAL CONTAINED>

6. 本製品は 52746-***81 の鉛フリー品です
 THIS PRODUCT IS LEAD FREE OF 52746-***81

7. 本製品は乾燥剤入り、ハイバリア梱包仕様である。
 THIS PRODUCT IS HIGH BARRIER PACKAGE WITH DESICCANT.

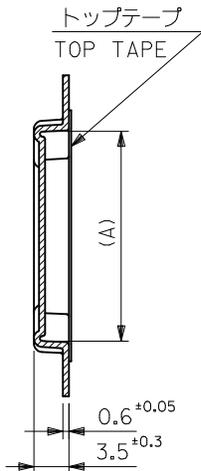
MODEL No.52746-***71

REVISED EC NO: J2009-2061 DRWN:TKON CHKD:HATSUMOTO APPR:NUKITA	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	±0.2	DRAWN BY HSHIMABUKURO	DATE '04/01/30	TITLE 0.5 FPC CONN ZIF SMT RA B/CONT EMBSTP PKG -LEAD FREE-		
	10 OVER 30 UNDER	±0.25	CHECKED BY KTOJO	DATE '04/01/30			
	30 OVER	±0.3	APPROVED BY MSASAO	DATE '04/01/30	MOLEX INCORPORATED		
	ANGULAR ±3 °		MATERIAL NO. SEE SHEET 2,3				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

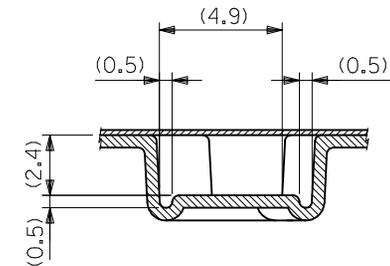
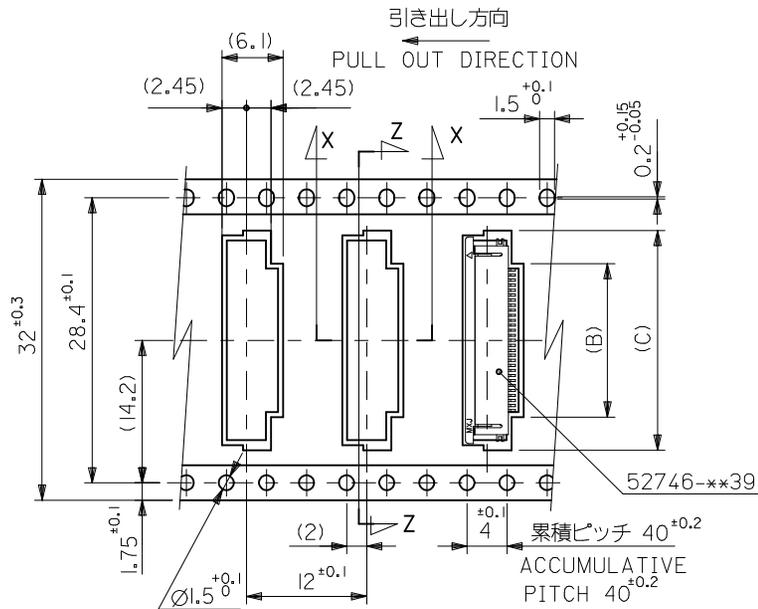


24	29.4	25.4	24.4	11.8	17.4	52746-2271	22
			17.9	11.3	16.9	52746-2171	21
			17.4	10.8	16.4	52746-2071	20
			16.9	10.3	15.9	52746-1971	19
			16.4	9.8	15.4	52746-1871	18
			15.9	9.3	14.9	52746-1771	17
			15.4	8.8	14.4	52746-1671	16
			14.9	8.3	13.9	52746-1571	15
			14.4	7.8	13.4	52746-1471	14
			13.9	7.3	12.9	52746-1371	13
			13.4	6.8	12.4	52746-1271	12
			12.9	6.3	11.9	52746-1171	11
			12.4	5.8	11.4	52746-1071	10
			11.9	5.3	10.9	52746-0971	9
			11.4	4.8	10.4	52746-0871	8
			10.9	4.3	9.9	52746-0771	7
10.4	3.8	9.4	52746-0671	6			
9.4	2.8	8.4	52746-0471	4			
16	21.4	17.4	9.4	2.8	8.4	52746-0471	4

キャリアテープ幅 CARRIER TAPE WIDTH	E	D	(C)	(B)	(A)	MATERIAL NO.	極数 CIRCUITS
DIMENSION STYLE MM ONLY							SCALE ---
GENERAL TOLERANCES (UNLESS SPECIFIED)							DESIGN UNITS METRIC
DRAWN BY HSHIMABUKURO							DATE '04/01/30
CHECKED BY KTOJO							DATE '04/01/30
APPROVED BY MSASAO							DATE '04/01/30
MATERIAL NO. SEE TABLE							DOCUMENT NO. SD-52746-024
TITLE 0.5 FPC CONN ZIF SMT RA B/CONT EMBSTP PKG -LEAD FREE-							SHEET NO. 2 OF 3
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							



SECT.Z-Z

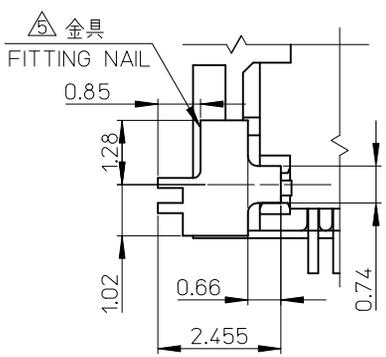
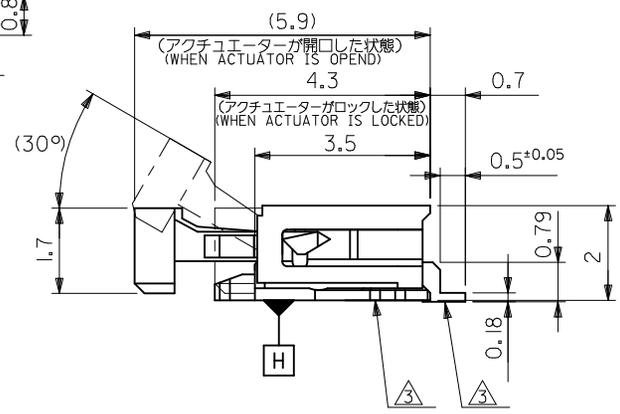
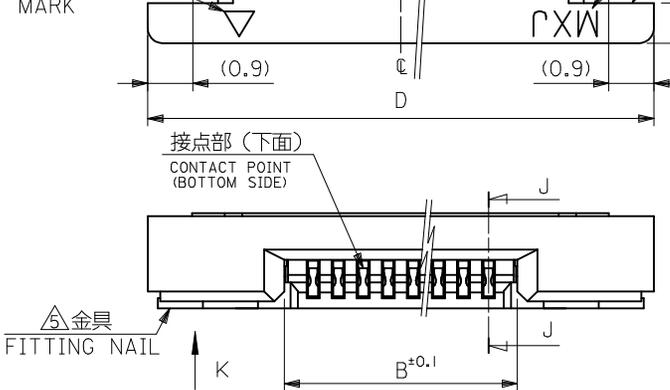
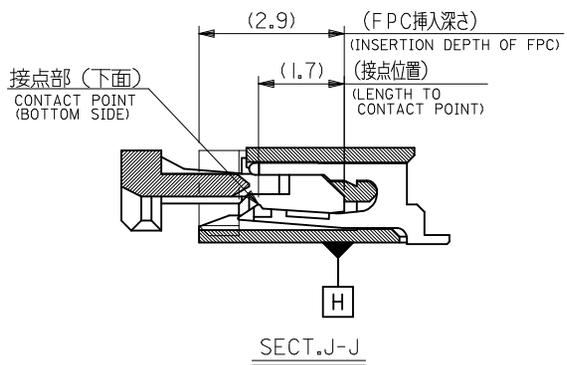
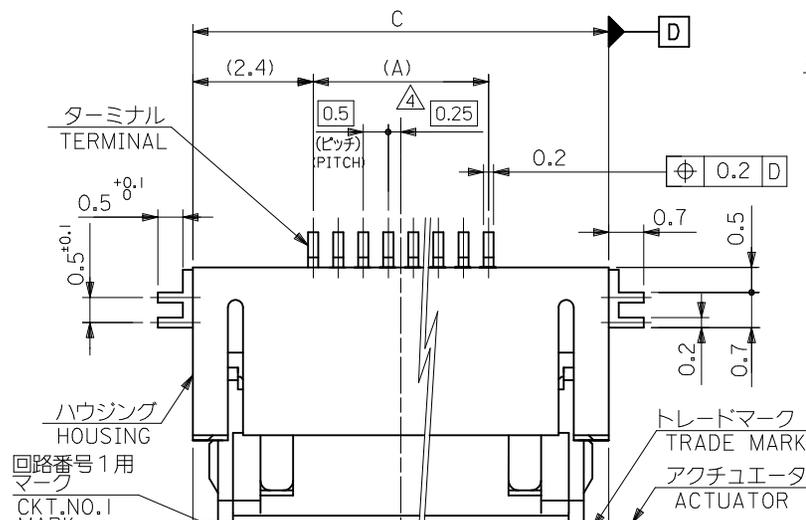


SECT.X-X

32mm幅キャリアテープ
32mm WIDTH CARRIER TAPE

32	37.4	33.4	22.4	15.8	21.4	52746-3071	30
			21.4	14.8	20.4	52746-2871	28
			20.9	14.3	19.9	52746-2771	27
			19.9	13.3	18.9	52746-2571	25
			19.4	12.8	18.4	52746-2471	24
キャリアテープ幅 CARRIER TAPE WIDTH	E	D	(C)	(B)	(A)	MATERIAL NO.	極数 CIRCUIT

REVISED EC NO: J2009-2061 DRWN:TKON 2009/05/20 CHKD:HMATSUMOTO 2009/05/21 APPR:NUKITA 2009/05/21	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)	DIMENSION STYLE MM ONLY	SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	REV	10 UNDER ±0.2	DRAWN BY HSHIMABUKURO	DATE '04/01/30	TITLE 0.5 FPC CONN ZIF SMT RA B/CONT EMBSTP PKG -LEAD FREE-	
		10 OVER 30 UNDER ±0.25	CHECKED BY KTOJO	DATE '04/01/30	MOLEX INCORPORATED	
		30 OVER ±0.3	APPROVED BY MSASAO	DATE '04/01/30	DOCUMENT NO. SD-52746-024	SHEET NO. 3 OF 3
		ANGULAR ±3 °	MATERIAL NO. SEE TABLE	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS					

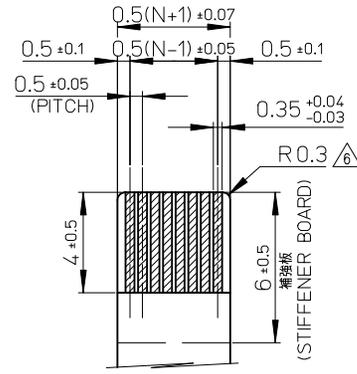


VIEW K
(金具部投影図)
(DETAIL OF FITTING NAIL)

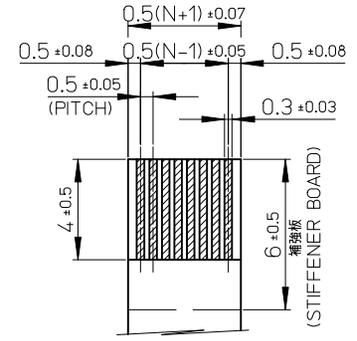
21.1	19.3	15.65	14.5	52746-3071	30
20.1	18.3	14.65	13.5	52746-2871	28
19.6	17.8	14.15	13	52746-2771	27
18.6	16.8	13.15	12	52746-2571	25
18.1	16.3	12.65	11.5	52746-2471	24
17.1	15.3	11.65	10.5	52746-2271	22
16.6	14.8	11.15	10	52746-2171	21
16.1	14.3	10.65	9.5	52746-2071	20
15.6	13.8	10.15	9	52746-1971	19
15.1	13.3	9.65	8.5	52746-1871	18
14.6	12.8	9.15	8	52746-1771	17
14.1	12.3	8.65	7.5	52746-1671	16
13.6	11.8	8.15	7	52746-1571	15
13.1	11.3	7.65	6.5	52746-1471	14
12.6	10.8	7.15	6	52746-1371	13
12.1	10.3	6.65	5.5	52746-1271	12
11.6	9.8	6.15	5	52746-1171	11
11.1	9.3	5.65	4.5	52746-1071	10
10.6	8.8	5.15	4	52746-0971	9
10.1	8.3	4.65	3.5	52746-0871	8
9.6	7.8	4.15	3	52746-0771	7
9.1	7.3	3.65	2.5	52746-0671	6
8.1	6.3	2.65	1.5	52746-0471	4
D	C	B	(A)	EMBOSSED PACKAGE ORDER No. オーダー番号	極数 CKT.

CONNECTOR SERIES NO. : 52746-**39

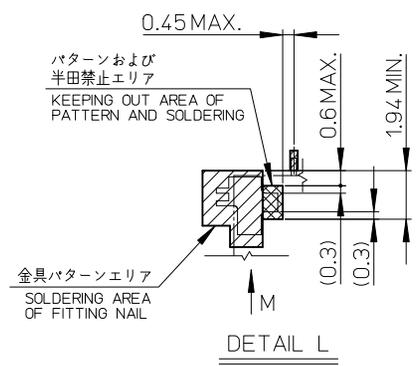
REVISED EC NO. J2011-0041 DRWN:HYOSHINO 2010/07/08 CHKD:HIJIMA 2010/07/08 APPR:KMORIKAWA 2010/07/16	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 10:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
	10 UNDER ±0.2	10 OVER 30 UNDER ±0.25	DRAWN BY HSHIMABUKURO	DATE '04/01/30	TITLE 0.5 FPC CONN. ZIF FOR SMT R/A (BOTTOM CONTACT) GOLD PLATING			
	30 OVER ±0.3	ANGULAR ±3 °	CHECKED BY KTOJO	DATE '04/01/30	MOLEX INCORPORATED			
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		APPROVED BY MSASAO	DATE '04/01/30	MATERIAL NO. SEE TABLE	DOCUMENT NO. SD-52746-025	SHEET NO. 1 OF 2	
THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION								



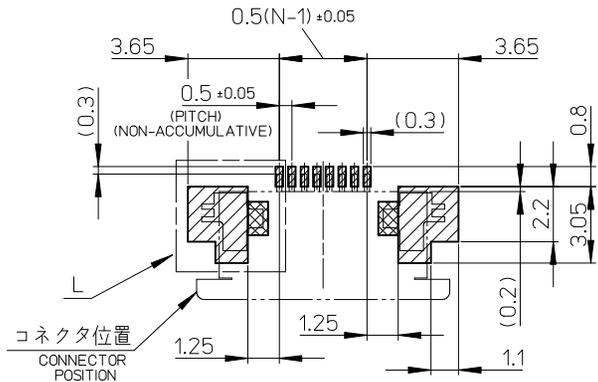
適合金めっきFPC推奨寸法
 APPLICABLE FPC OF GOLD
 PLATING RECOMMENDED DIMENSION
 仕上がり厚さ: 0.3±0.03
 THICKNESS: 0.3+0.03/-0.03



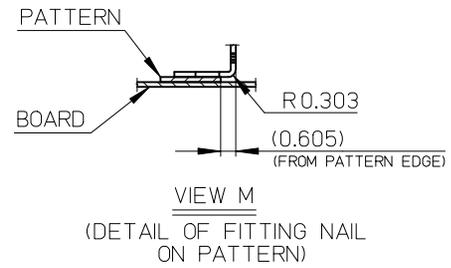
適合金めっきFPC推奨寸法
 APPLICABLE FPC OF GOLD
 PLATING RECOMMENDED DIMENSION
 仕上がり厚さ: 0.3±0.03
 THICKNESS: 0.3+0.03/-0.03



DETAIL L



参考基板レイアウト
 (マウント面)
 RECOMMENDED P.C.BOARD
 PATTERN DIMENSION(REF.)
 (MOUNTING SIDE)



VIEW M
 (DETAIL OF FITTING NAIL
 ON PATTERN)

注記NOTES

- 1.使用材料
 MATERIAL
 ハウジング: 46ナイロン、ガラス充填、UL94V-0、白
 HOUSING: PA46, GLASS FILLED, UL94V-0, WHITE
 アクチュエータ: ポリフェニレンサルファイド (PPS)、ガラス充填、UL94V-0、茶色
 ACTUATOR: POLYPHENYLENE SULFIDE, GLASS FILLED, UL94V-0, BROWN
 ターミナル: リン青銅、ニッケル下地金めっき (t=0.2)
 TERMINAL: PHOSPHOR BRONZE, GOLD OVER NICKEL PLATING
 金具: リン青銅、ニッケル下地金めっき (t=0.2)
 FITTING NAIL: PHOSPHOR BRONZE, TIN OVER NICKEL PLATING
- 2.エンボステープ梱包時は、アクチュエータがロックした状態になります。
 IN THE PACKAGE, ACTUATOR OF PART
 NO.52746-***39 SHOULD BE LOCKED.
- 3.ソルダータール半田付け面のズレ量、及び金具半田付け面のズレ量は、
 基準面Hに対して上方向に0.1MAXIMUM、下方向0.15MAXIMUMとする。
 MISALIGNMENT OF SOLDER TAILS AND FITTING NAILS FROM
 DATUM-H.
 UPPER DIRECTION: 0.1MAXIMUM
 LOWER DIRECTION: 0.15 MAXIMUM
- 4.偶数極に適用
 APPLY FOR EVEN CIRCUIT.
- 5.ハ' ターン刻難止め金具
 FITTING NAIL FOR PREVENTION OF PEELING OF P.W.B. PATTERN.
- 6.R0.3は、FPCの導体部にかからないこと
 R0.3 MUST NOT BE OVERLAPED TO PATTERN OF FPC.
- 7.ELV 及び RoHS 適合品
 ELV AND RoHS COMPLIANT

FPCについて:
 打ち抜き方向は導体側から補強板を推奨いたします。
 補強フィルム材質はポリイミドを推奨いたします。
 ABOUT FPC:
 RECOMMENDED PUNCHER DIRECTION: FROM CONDUCTOR SIDE TO STIFFNER BOARD SIDE.
 RECOMMENDED MATERIAL: POLYIMIDE
 STIFFNER FILM: POLYIMIDE
 BONDING AGENT: THERMOSETTING BONDING AGENT

REVISED EC NO: J2011-0041 DRWN:HYOSHINO 2010/07/08 CHKD:HIJIMA 2010/07/08 APPR:KMORIKAWA 2010/07/16	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 5:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION
	10 UNDER	± ---	DRAWN BY HSHIMABUKURO	DATE '04/01/30	TITLE 0.5 FPC CONN. ZIF FOR SMT R/A (BOTTOM CONTACT) GOLD PLATING		
	10 OVER 30 UNDER	± ---	CHECKED BY KTOJO	DATE '04/01/30	MOLEX INCORPORATED		
	30 OVER	± ---	APPROVED BY MSASAO	DATE '04/01/30	DOCUMENT NO. SD-52746-025		
ANGULAR	± --- °	MATERIAL NO. SEE TABLE		SHEET NO. 2 OF 2			
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

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В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

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moschip.ru_6

moschip.ru_9